

High power NPN epitaxial planar bipolar transistor

Preliminary data

Features

- High breakdown voltage V_{CEO} = 230 V
- Typical f_T = 30 MHz

Application

■ Audio power amplifier

Description

This device is a NPN transistor manufactured using new BiT-LA (bipolar transistor for linear amplifier) technology. The resulting transistor shows good gain linearity behaviour.

Josoleite Productils

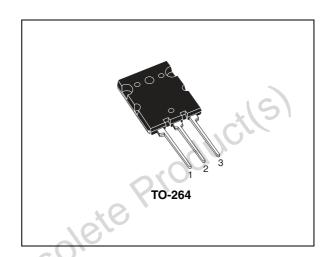


Figure 1. Internal schematic diagram

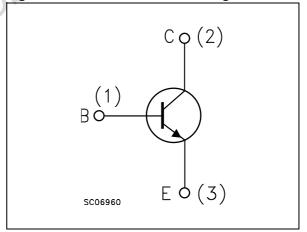


Table 1. Device summary

Order code	Marking	Package	Packaging
2SC5200	2SC5200	TO-264	Tube

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Electrical ratings 2SC5200

Electrical ratings 1

Table 2. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-base voltage (I _E = 0)	230	V
V _{CEO}	Collector-emitter voltage (I _B = 0)	230	V
V _{EBO}	Emitter-base voltage (I _C = 0)	5	V
I _C	Collector current	15	Α
I _{CM}	Collector peak current	30	А
P _{TOT}	Total dissipation at T _C = 25 °C	150	W
T _{STG}	Storage temperature	-55 to 150	°C
TJ	Operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case max	0.83	°C/W
Pi	oducils		
etePI			

Electrical characteristics 2

T_{case} = 25 °C unless otherwise specified

Table 4. **Electrical characteristics**

230 230 5	900	5	μΑ μΑ V
230	900	5	V
230	9/n		
(0	90,		٧
5			
			٧
_B = 800 mA		3	V
/ _{CE} = 5 V		1.5	V
$V_{CE} = 5 \text{ V}$ 55 $V_{CE} = 5 \text{ V}$ 35	80	120	
I _C = 5A 5 A	0.24 4.7 0.6		μs μs μs
/ _{CE} = 5 V	30		MHz
f = 1 MHz	150		pF
	CE = 5 V	_{CE} = 5 V 30	CE = 5 V 30

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

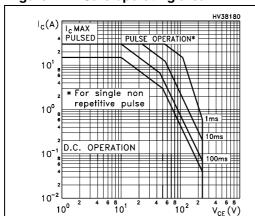
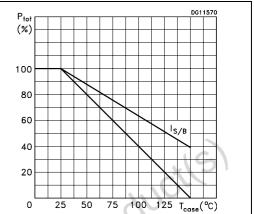
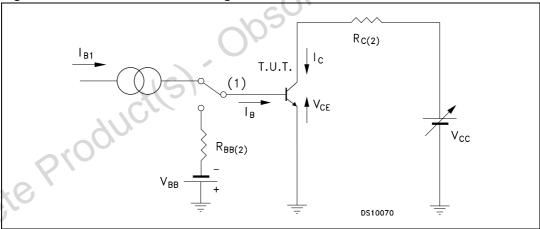


Figure 3. Derating curve



2.2 Test circuit

Figure 4. Resistive load switching test circuit



- 1. Fast electronic switch
- 2. Non-inductive resistor

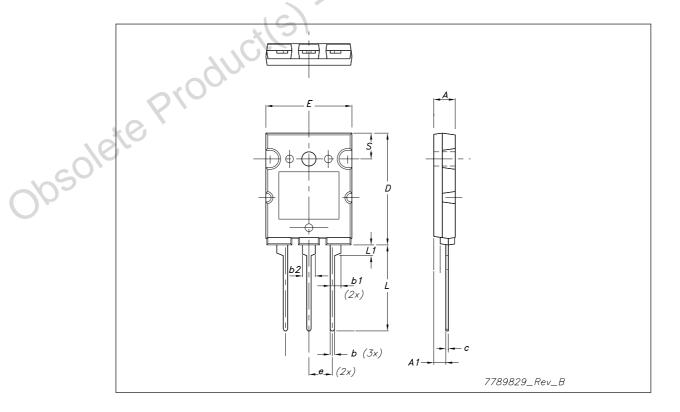
3 Package mechanical data

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Obsolete Product(s). Obsolete Product(s)

TO	264	Mac	hanica	l data
	-/n4	IVIEC	nanica	ı nata

Dim.	mm.			
Dilli.	Min.	Тур	Max.	
Α	4.80		5.20	
A1	2.50		3.10	
b	0.90	1.0	1.25	
b1		2.5	.(5)	
b2		2.8	(C)	
С	0.50	0.60	0.85	
D	25.6		26.4	
E	19.80		20.20	
е	5.15	9/2	5.75	
L	19.50	76,	20.50	
L1	2.30	1250	2.70	
øΡ	3.55	103	3.65	



2SC5200 Revision history

4 Revision history

Table 5. Document revision history

Date	Revision	Changes
28-Sep-2009	1	Initial release.



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